



ENGINEERING DEPT.

PRODUCT SPECIFICATION

SPEC.NO.: SPCI029D

REVISIONS | ECNT120150

For CI47 Series Connector System

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1. SCOPE:

This specification contains the test requirement of subject connectors when tested under the condition and procedure with terminals crimped on the specified maximum size wire

2. APPLICABLE STANDARDS:

MIL - STD - 202

Methods for test of connectors for electronic equipment

EIA - 364

Test methods for electrical connectors

- 3. APPLICABLE SERIES NO: CI47 Series
- 4. SHAPE, CONSTRUCTION AND DIMENSIONS See attached drawings
- 5. MATERIALS:

See attached drawings

6. ACCOMMODATED P.C.BOARD

6.1 Thickness: $0.4 \text{ mm} (.016'') \sim 0.6 \text{ mm} (.024'')$ 6.2 P.C. Board Layout: See attached drawings

REVIEWED: Eisley APPROVED: Sun VERIFIED: Michelle.





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7. ELECTRICAL PERFORMANCE:

| | ITEM | TEST CONDITION | REQUIREMENT |
|-----|---------------------------|---|--------------------------|
| 7.1 | Rated current and voltage | | 1A 100V AC (r.m.s.) |
| 7.2 | Contact resistance | Dry circuit of DC 20 mV max., 100 mA max. | Less than 20 mΩ |
| 7.3 | Dielectric strength | When applied AC 500 V 1 minute between adjacent terminal | No change |
| 7.4 | Insulation resistance | When applied DC 500 V between adjacent terminal or ground | More than 500 M Ω |

8. MECHANICAL PERFORMANCE:

| | ITEM | TEST CONDITION | REQUIREMENT |
|-----|--------------------------------------|---|---|
| 8.1 | Wire size | Specified wire size | Accepts AWG#28~#32 |
| 8.2 | Terminal crimp Tensile | When crimped AWG#28 size wire | More than 1.3 Kgf |
| | strength | When crimped AWG#30 size wire | More than 0.8 Kgf |
| | | When crimped AWG#32 size wire | More than 0.6 Kgf |
| 8.3 | Terminal insertion force | Insertion speed 25± 3 mm per minute into housing | Less than 300 gram |
| 8.4 | Contact retaining force in insulator | Retention speed 25± 3 mm per minute from housing | More than 0.7 Kgf |
| 8.5 | Single contact insertion force | Measure force to insertion using 0.50 mm square pin at speed 25± 3 mm per minute | 600 gram max. |
| 8.6 | Single contact withdrawal force | Measure force to withdrawal using 0.50 mm square pin at speed 25± 3 mm per minute | 70 gram min. |
| 8.7 | Durability | Connector shall be subjected to 100 cycles of insertion and withdrawal | Contact resistance: Less than twice of initial |
| 8.8 | Pin retention force | Push pin from insulator base at speed | More than 0.4 Kgf |
| | | 25± 3 mm per minute | |

9. ENVIRONMENTAL PERFORMANCE:

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|-----|------------------------------------|--|--------------------------------------|--|
| | ITEM | TEST CONDITION | REQUIREMENT | |
| 9.1 | Temperature rise | Then carried the rated current | 30°C max. | |
| 9.2 | Vibration | 1.5 mm 10-55-10 HZ / minute each 2 hours for X, Y and Z directions | Appearance: No damage Discontinuity: | |
| | | | 1 micro second max. | |





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| | ITEM | TEST CONDITION | REQUIREMENT |
|-----|------------------------------|---|--|
| 9.3 | Solder ability | Soldering time: 5 ± 0.5 second | Minimum: |
| | | Soldering pot: 230 ± 5 °C | 90% of immersed area |
| 9.4 | Resistance to soldering heat | Soldering time: 5 ± 0.5 second | No damage |
| | | Soldering pot: 260 ± 5 °C | |
| 9.5 | Heat aging | 85 ± 2°C , 96 hours | No damage |
| 9.6 | Humidity | $40 \pm 2^{\circ}\text{C}$, 90-95% RH , 96 hours measurement must be taken within 30 min. after tested | Appearance: No damage Contact resistance: Less than twice of initial Dielectric strength: To pass para 7-3 |
| 9.7 | Temperature cycling | One cycle consists of : | Appearance: No damage |
| 7.7 | remperature cycling | (1) $-55 + 0 \circ C$, 30 min. | Contact resistance: |
| | | (2)Room temp. 10-15 min. (3) 85 +3 °C, 30 min. (4)Room temp. 10-15 min. | Less than twice of initial |
| 9.8 | Salt spray | Temperature: 35 ± 3 °C | Appearance: No damage |
| | | Solution: 5 ± 1% | Contact resistance: |
| | | Spray time: 48 ± 4 hours | Less than twice of initial |
| | | (Stamping before plated) | |
| | | Spray time: 24 ± 4 hours | |
| | | (Stamping after plated) | |
| | | Mate connectors and expose to the following salt mist conditions. Upon completion of the exposure period, salt deposits shall be removed by a gentle wash or dip in running water and dried naturally, after which the specified measurements shall be performed. | |
| | | The specimens shall be suspended from the top using waxed twine, string or nylon thread. The test only define the plating area, without plating area (as copper cross section) will not be defined. (EIA 364-26B / MIL-STD-202 Method 101) | |

10. AMBIENT TEMPERATURE RANGE: -25 to +85°C